16562 U.S. I

PATENT APPLICATION COVER SHEET

_		
ጋሳር	ket	

HONORABLE COMMISSIONER OF PATENTS AND TRADEMARKS

Washington, D.C. 20231

Sir:

Transmitted herewith for filing is the patent application of:

INVENTOR: WAYNE SPEARS

FOR: PIPE FITTING HAVING OVER-SIZED STRENGTHENED STARTER THREADS

Enclosed are:

- ☐ An assignment of the invention to:
- ☐ The check below includes \$40 for the recordation of the Assignment
- □ A verified statement to establish small entity status under 37 C.F.R. 1.9 and 37 C.F.R. 1.27 (Independent Inventor)
- □ Information Disclosure Statement
- □ Declaration and Power of Attorney .
- The filing fee has been calculated as shown below:

1) (Col. 2)	SMALL

SMALL ENTITY		
RATE	FEE	
	\$	
х9	\$	
x42	\$	
+140	\$	
TOTAL	\$	

SMALL	ENTIT	Y
OTHER	THAN	Α

RATE	REE
	\$770
x18	\$
x84	\$
+280	\$
TOTAL	\$770

FOR:	No. Filed	No. Extra
BASIC FEE		
TOTAL CLAIMS	3 - 20 =	0
INDEPENDENT CLAIMS	2 - 3 =	0
MULTIPLE DEPENDENT CLAIMS PRESENTED		

(Col.

If the difference in Col. 1 is less than than zero, enter "0" in Col. 2

Please charge Deposit Account No.	19-2090 in the amount of \$	
J Flease Charge Debusit Account 110.	1)-20)0 III the amount of ϕ	The second secon

 \boxtimes A check in the amount of \$ $\underline{770.00}$ to cover the filing fee is enclosed.

The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 19-2090.

Any additional fees required under 37 C.F.R. § 1.16 Any patent application processing fees under 37 C.F.R. § 1.17

The Commissioner is hereby authorized to charge payment of the following fees during the pendency of this application or credit any overpayment to Deposit Account No. 19-2090:

Any patent application processing fees under 37 C.F.R. § 1.17. Any filing fees under 37 C.F.R. § 1.16 for presentation of extra claims.

SHELDON & MAK

Date: April 16, 2004

3v: 9

Kristin C. Hiibner, Ph.D.

Registration No. 50,139

<u>CERTIFICATE OF MAILING:</u> I hereby certify that this correspondence is being deposited with the U.S. Postal Service via Express Mail, Mailing Label No. EV390736474US, in an envelope addressed to: Commissioner for Patents, Box Patent Application, Washington,

D.C. 20231 on April 16, 2004.

225 South Lake Avenue, 9th Floor Pasadena, California 91101

Date: April 16, 2004

(626) 796-4000

By:

Jennifer Ankai